

MOS FIELD EFFECT TRANSISTOR $\mu PA1917$

P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA1917 is a switching device which can be driven directly by a 1.8 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- 1.8 V drive available
- Low on-state resistance
- $\begin{array}{lll} R_{DS(on)1} = & 53 \ m\Omega \ MAX. \ (V_{GS} = -4.5 \ V, \ I_{D} = -3.0 \ A) \\ R_{DS(on)2} = & 70 \ m\Omega \ MAX. \ (V_{GS} = -2.5 \ V, \ I_{D} = -3.0 \ A) \\ R_{DS(on)3} = & 107 \ m\Omega \ MAX. \ (V_{GS} = -1.8 \ V, \ I_{D} = -1.5 \ A) \\ \end{array}$

ORDERING INFORMATION

PART NUMBER	PACKAGE		
μΡΑ1917ΤΕ	SC-95 (Mini Mold Thin Type)		

Marking : TR

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

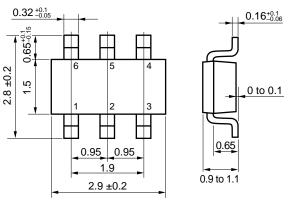
VDSS	-20	V
Vgss	∓8.0	V
D(DC)	∓6.0	А
D(pulse)	∓24	А
P _{T1}	0.2	W
P T2	2.0	W
Tch	150	°C
Tstg	-55 to +150	°C
	VGSS ID(DC) ID(pulse) PT1 PT2 Tch	VGSS ∓8.0 ID(DC) ∓6.0 ID(pulse) ∓24 PT1 0.2 PT2 2.0 Tch 150

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

- **2.** Mounted on FR-4 board, $t \le 5$ sec.
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

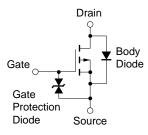
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PACKAGE DRAWING (Unit : mm)



1, 2, 5, 6 : Drain 3 : Gate 4 : Source

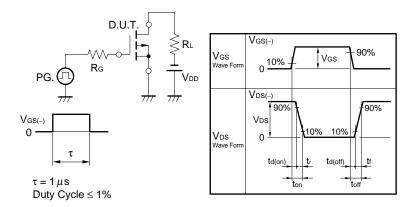
EQUIVALENT CIRCUIT



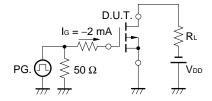
ELECTRICAL	CHARACTERISTICS ($T_A = 25^{\circ}C$)	

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -20 V, V_{GS} = 0 V$			-10	μA
Gate Leakage Current	lgss	$V_{GS} = \mp 8.0 \text{ V}, \text{ Vds} = 0 \text{ V}$			∓10	μA
Gate to Source Cut-off Voltage	V _{GS(off)}	$V_{DS} = -10 \text{ V}, \text{ ID} = -1.0 \text{ mA}$	-0.45	-0.75	-1.5	V
Forward Transfer Admittance	y _{fs}	$V_{DS} = -10 \text{ V}, \text{ ID} = -3.0 \text{ A}$	5.0	10.4		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = −4.5 V, Id = −3.0 A		42	53	mΩ
	RDS(on)2	Vgs = −2.5 V, Id = −3.0 A		52	70	mΩ
	RDS(on)3	Vgs = −1.8 V, Id = −1.5 A		64	107	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V		835		pF
Output Capacitance	Coss	V _{GS} = 0 V		170		pF
Reverse Transfer Capacitance	Crss	f = 1.0 MHz		99		pF
Turn-on Delay Time	td(on)	$V_{DD} = -10 \text{ V}, \text{ ID} = -3.0 \text{ A}$		16		ns
Rise Time	tr	Vgs = -4.0 V		64		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		78		ns
Fall Time	tr			108		ns
Total Gate Charge	Q _G	V _{DD} = -16 V		8.1		nC
Gate to Source Charge	QGS	V _{GS} = -4.0 V		1.3		nC
Gate to Drain Charge	Qgd	ID = -6.0 A		2.8		nC
Diode Forward Voltage	VF(S-D)	IF = 6.0 A, VGS = 0 V		0.94		V

TEST CIRCUIT 1 SWITCHING TIME



TEST CIRCUIT 2 GATE CHARGE



75

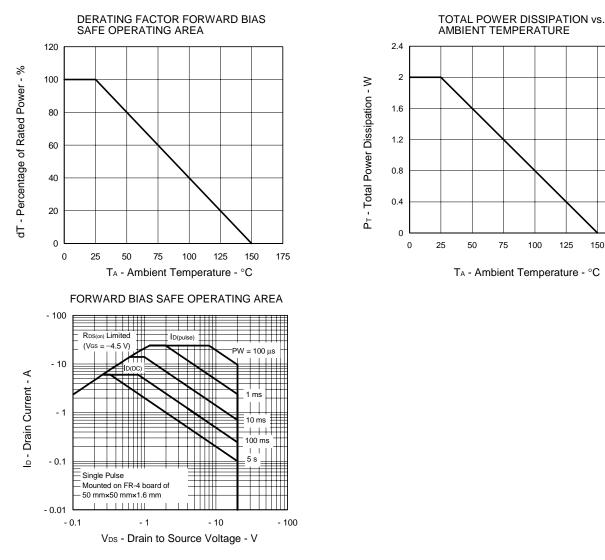
100

125

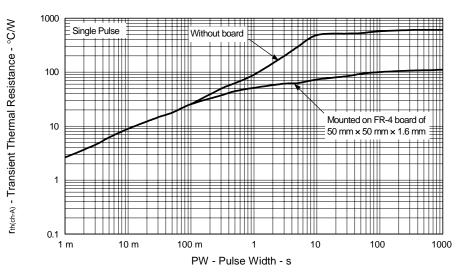
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175

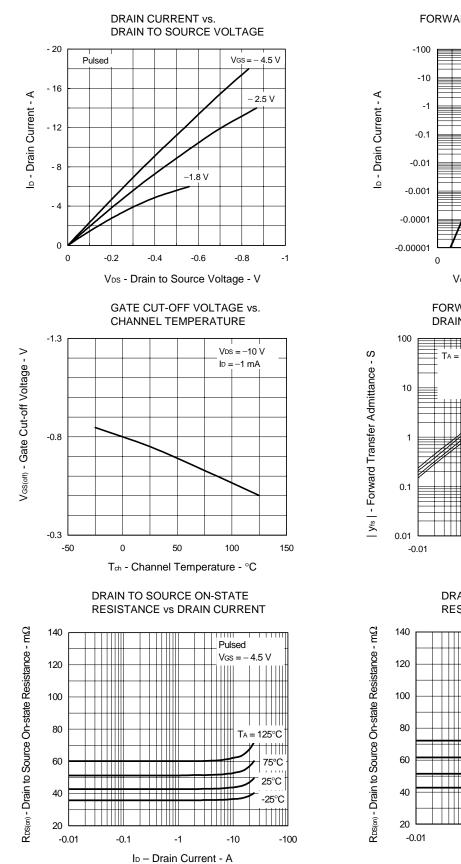
TYPICAL CHARACTERISTICS (TA = 25°C)



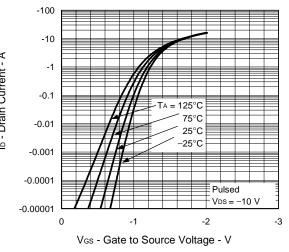
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



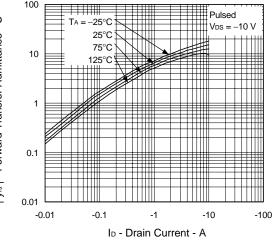
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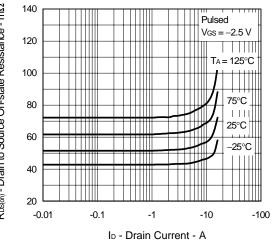
FORWARD TRANSFER CHARACTERISTICS



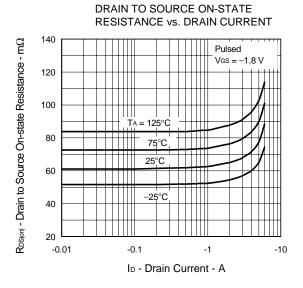
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

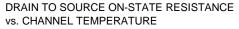


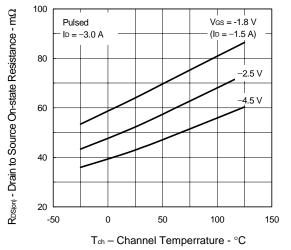
DRAIN TO SOURCE ON-STATE RESISTANCE vs.DRAIN CURRENT



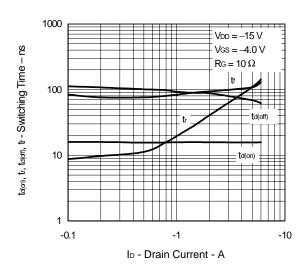
NEC

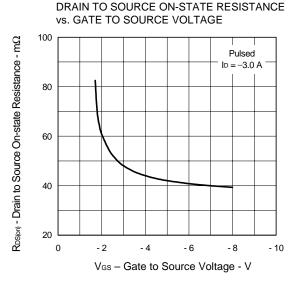


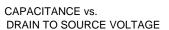


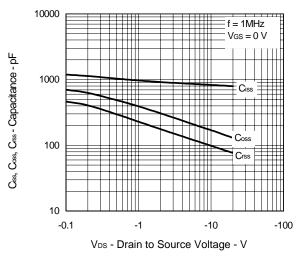




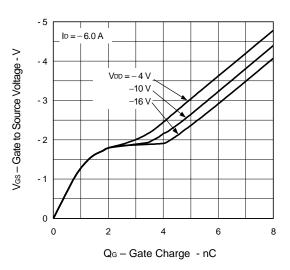




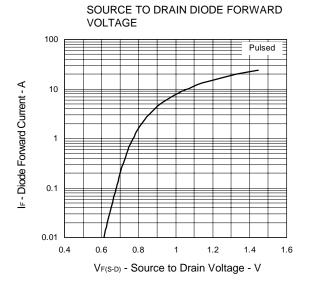








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[MEMO]

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